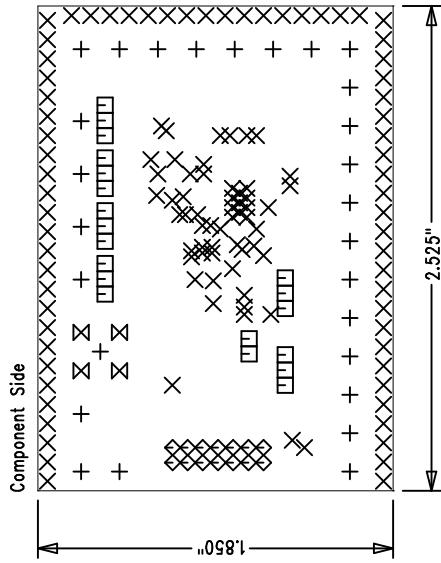


REV		REVISIONS		APPR		DATE



ART01 = LAYER 1 ( COMPONENT SIDE )  
 ART02 = LAYER 2 ( GND )  
 ART03 = LAYER 3 ( GND )  
 ART04 = LAYER 4 ( SOLDER SIDE )

**NOTES : Unless Otherwise Specified**

1. MATERIAL : FR4 OR EQUIVALENT EPOXY, 2 OZ. COPPER CLAD THICKNESS .062 +/- .006 TOTAL OF 4 LAYERS
2. FINISH : ALL PLATED HOLES .001 MIN. / .0015 MAX. COPPER PLATE ELECTRODEPOSITED TIN-LEAD COMPOSITION BEFORE REFLOW , SOLDER MASK OVER BARE COPPER (SMOBC)
3. SOLDER MASK : BOTH SIDES USING LPI OR EQUIVALENT
4. SILKSCREEN : USING WHITE NON-CONDUCTIVE EPOXY INK
5. ALL DIMENSIONS ARE IN INCHES

**Fabrication Drawing**

APPROVALS		LINEAR TECHNOLOGY	
DRAWN	INIT	DATE	
CHECK			
DESIGN			
ENGR			
Title:	LTC2447UHF		
24-Bit High Speed 4-/8-Channel Delta Sigma ADC			
Size:	Demo Board:	DC846A	Rev.
None			
Scale = None	Design #		Sht: 1 of 1